Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: http://www.renesas.com

April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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NPN SILICON RF TRANSISTOR **2SC3357**

NPN EPITAXIAL SILICON RF TRANSISTOR FOR HIGH-FREQUENCY LOW-NOISE AMPLIFICATION 3-PIN POWER MINIMOLD

FEATURES

- Low noise and high gain
- NF = 1.1 dB TYP., Ga = 7.5 dB TYP. @ VCE = 10 V, IC = 7 mA, f = 1 GHz
 NF = 1.8 dB TYP., Ga = 9.0 dB TYP. @ VCE = 10 V, IC = 40 mA, f = 1 GHz
- High power gain : MAG = 10 dB TYP. @ Ic = 40 mA, f = 1 GHz
 - Large Ptot : Ptot = 1.2 W (Mounted on 16 cm² × 0.7 mm (t) ceramic substrate)
 - Small package : 3-pin power minimold package

★ ORDERING INFORMATION

Part Number	Quantity	Supplying Form
2SC3357	25 pcs (Non reel)	• 12 mm wide embossed taping
2SC3357-T1	1 kpcs/reel	Collector face the perforation side of the tape

Remark To order evaluation samples, contact your nearby sales office. The unit sample quantity is 25 pcs.

ABSOLUTE MAXIMUM RATINGS (TA = +25°C)

Parameter	Symbol	Ratings	Unit
Collector to Base Voltage	Vсво	20	V
Collector to Emitter Voltage	Vceo	12	V
Emitter to Base Voltage	Vebo	3.0	V
Collector Current	lc	100	mA
Total Power Dissipation	Ptot ^{Note}	1.2	W
Junction Temperature	Tj	150	°C
Storage Temperature	Tstg	-65 to +150	°C

Note Mounted on 16 $\text{cm}^2 \times 0.7 \text{ mm}$ (t) ceramic substrate

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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The mark \star shows major revised points.

THERMAL RESISTANCE

Parameter	Symbol	Value	Unit
Junction to Ambient Resistance	$R_{\text{th (j-a)}}^{\text{Note}}$	62.5	°C/W

Note Mounted on 16 cm² \times 0.7 mm (t) ceramic substrate

ELECTRICAL CHARACTERISTICS (TA = +25°C)

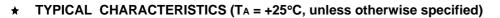
Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
DC Characteristics						
Collector Cut-off Current	Ісво	Vсв = 10 V, IE = 0 mA	-	-	1.0	μA
Emitter Cut-off Current	Ево	Vев = 1.0 V, Iс = 0 mA	-	-	1.0	μA
DC Current Gain	hfe Note 1	Vce = 10 V, Ic = 20 mA	50	120	250	-
RF Characteristics						
Gain Bandwidth Product	f⊤	Vce = 10 V, Ic = 20 mA	-	6.5	-	GHz
Insertion Power Gain	S _{21e} ²	Vce = 10 V, Ic = 20 mA, f = 1 GHz	-	9.0	-	dB
Noise Figure (1)	NF	Vce = 10 V, Ic = 7 mA, f = 1 GHz	-	1.1	-	dB
Noise Figure (2)	NF	Vce = 10 V, Ic = 40 mA, f = 1 GHz	_	1.8	3.0	dB
Reverse Transfer Capacitance	Cre ^{Note 2}	Vсв = 10 V, IE = 0 mA, f = 1 MHz	_	0.65	1.0	pF

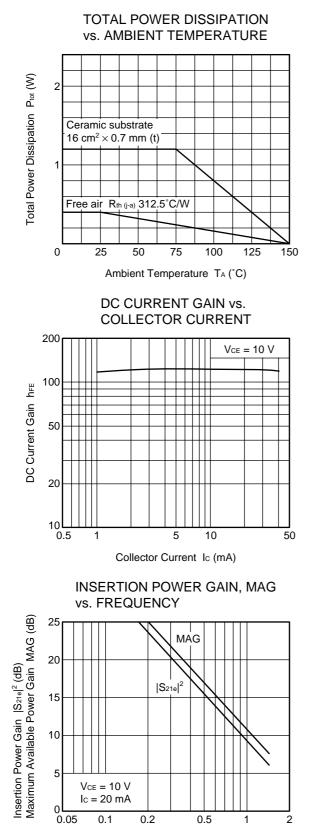
Notes 1. Pulse measurement: PW \leq 350 μ s, Duty Cycle \leq 2%

2. The emitter terminal and the case shall be connected to the guard terminal of the three-terminal capacitance bridge.

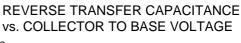
hfe CLASSIFICATION

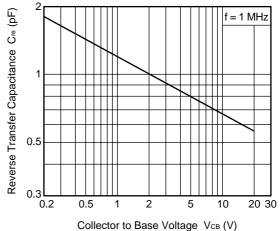
Rank	RH	RF	RE
Marking	RH	RF	RE
hfe Value	50 to 100	80 to 160	125 to 250





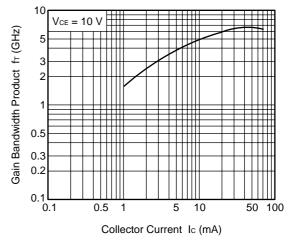
Frequency f (GHz)



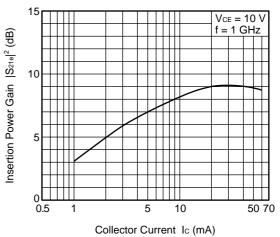


GAIN BANDWIDTH PRODUCT

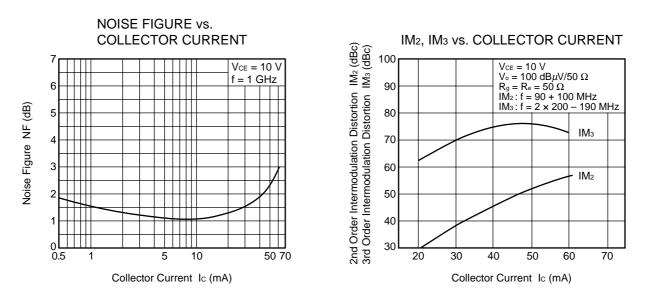
vs. COLLECTOR CURRENT



INSERTION POWER GAIN vs. COLLECTOR CURRENT



Data Sheet PU10211EJ01V0DS



Remark The graphs indicate nominal characteristics.

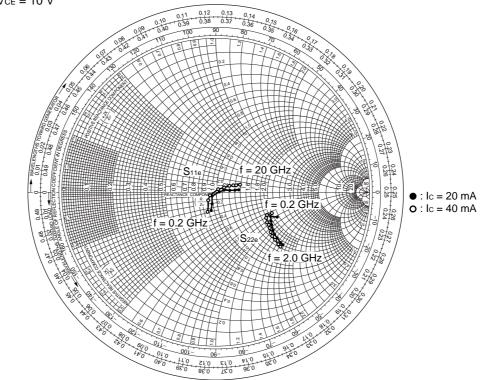
S-PARAMETERS

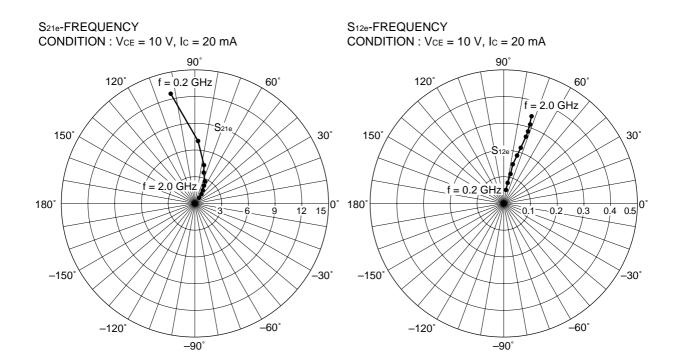
S-parameters/Noise parameters are provided on the NEC Compound Semiconductor Devices Web site in a form (S2P) that enables direct import to a microwave circuit simulator without keyboard input.

- Click here to download S-parameters.
- $[\mathsf{RF} \text{ and Microwave}] \rightarrow [\mathsf{Device Parameters}]$
- URL http://www.csd-nec.com/

★ SMITH CHART

S11e, S22e-FREQUENCY CONDITION : VCE = 10 V

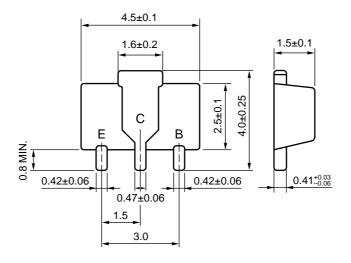




Data Sheet PU10211EJ01V0DS

★ PACKAGE DIMENSIONS

3-PIN POWER MINIMOLD (UNIT: mm)



PIN CONNECTIONS

- E : Emitter
- C: Collector (Fin)
- B : Base
- (IEC : SOT-89)

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M8E 00.4-0110

▶Business issue

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